

3.8x2.0mm DOME LENS SMD CHIP LED LAMP

White

Part Number: APED3820QWF/G



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

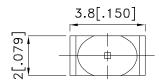
Features

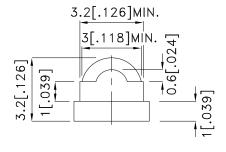
- 3.8mmx2.0mm SMT LED, 3.2mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Package : 500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

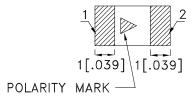
Descriptions

- The source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

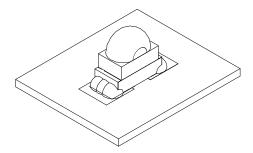
Package Dimensions











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
APED3820QWF/G	White (InGaN)	Yellow Fluorescent	200	350	175°

Notes:

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity/ luminous Flux: +/-15%.
 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol Parameter		Device	Тур.	Max.	Units	Test Conditions	
VF [1]	Forward Voltage	White	3.3	4.0	V	IF=20mA	
lr	Reverse Current	White		50	uA	VR = 5V	
X [2]	Chromoticity Coordinates	White	0.31				
Y [2]	Chromaticity Coordinates		0.31				
С	Capacitance	White	100		pF	VF=0V;f=1MHz	

- Notes:
 1.Forward Voltage: +/-0.1V.
 2.Measurement tolerance of the chromaticity coordinates is ±0.01.
- 3.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

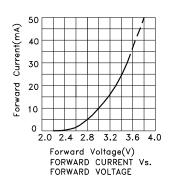
And or and a state of the state					
Parameter	White				
Power dissipation	120	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	150	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C	•			
Storage Temperature	-40°C To +85°C				

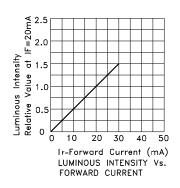
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

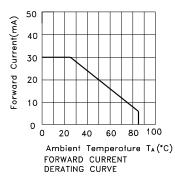
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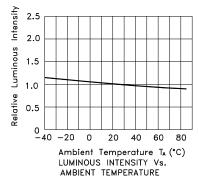
White

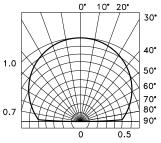
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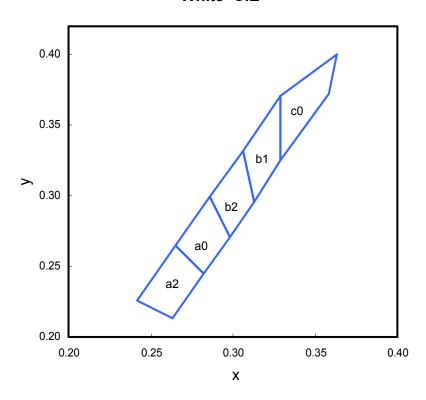
SPATIAL DISTRIBUTION

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	х	у		Х	у		х	у
	0.263	0.213	а0	0.282	0.245		0.298	0.271
a2	0.282	0.245		0.298	0.271	b2	0.313	0.296
az	0.265	0.265		0.286	0.299	IJŹ	0.306	0.332
	0.242	0.226		0.265	0.265		0.286	0.299
b1	0.313	0.296	c0	0.329	0.325			
	0.329	0.325		0.358	0.372			
	0.329	0.371		0.363	0.400			
	0.306	0.332		0.329	0.371			

Shipment may contain more than one chromaticity regions.

Orders for single chromaticity region are generally not accepted.

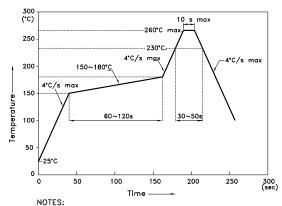
Measurement tolerance of the chromaticity coordinates is ±0.01.

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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



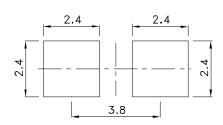
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

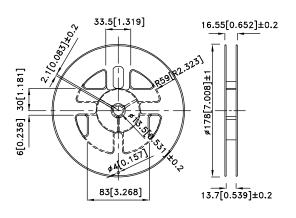
 3.Number of reflow process shall be 2 times or less.

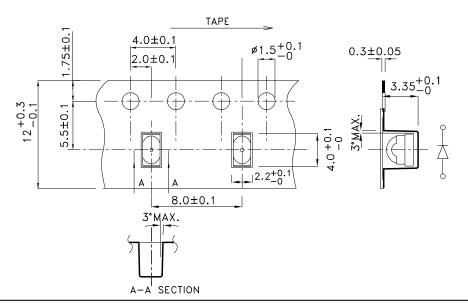
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units : mm)

Reel Dimension

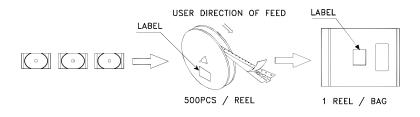


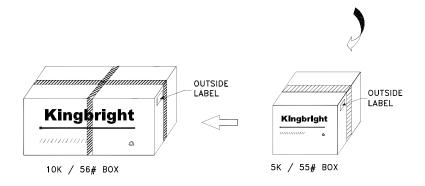


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PACKING & LABEL SPECIFICATIONS

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